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October 1995 Revised March 2001

### 74LCX16501

# **Low Voltage 18-Bit Universal Bus Transceivers** with 5V Tolerant Inputs and Outputs

### **General Description**

The LCX16501 is an 18-bit universal bus transceiver combining D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in <u>each</u> direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs.

The LCX16501 is designed for low voltage (2.5V or 3.3V)  $V_{CC}$  applications with capability of interfacing to a 5V signal environment

The LCX16501 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power.

### **Features**

- 5V tolerant inputs and outputs
- 2.3V–3.6V V<sub>CC</sub> specifications provided
- $\blacksquare$  6.0 ns t<sub>PD</sub> max (V<sub>CC</sub> = 3.3V), 20  $\mu$ A I<sub>CC</sub> max
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- $\pm$ 24 mA Output Drive (V<sub>CC</sub> = 3.0V)
- Implements patented noise/EMI reduction circuitry
- Latch-up performance exceeds 500 mA
- ESD performance:

Human body model > 2000V Machine model < 200V

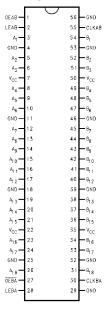
**Note 1:** To ensure the high-impedance state during power up or down,  $\overline{\text{OE}}$  should be tied to  $V_{CC}$  and OE tied to GND through a resistor: the minimum value or the resistor is determined by the current-sourcing capability of the

### **Ordering Code:**

Order Number	Package Number	Package Description
74LCX16501MEA	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300 Wide
74LCX16501MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Devices also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

### **Connection Diagram**



### **Truth Table**

(Note 2)

	Inputs				
OEAB	LEAB	CLKAB	An	B <sub>n</sub>	
L	Χ	Х	Х	Z	
Н	Н	Х	L	L	
Н	Н	X	Н	Н	
Н	L	$\uparrow$	L	L	
Н	L	$\uparrow$	Н	Н	
Н	L	Н	Х	B <sub>0</sub> (Note 3)	
Н	L	L	Х	B <sub>0</sub> (Note 4)	

Note 2: A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, and CLKBA.

Note 3: Output level before the indicated steady-state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW.

Note 4: Output level before the indicated steady-state input conditions were established.

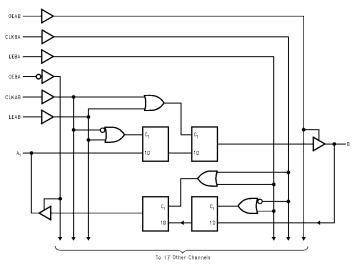
### **Functional Description**

For A-to-B data flow, the LCX16501 operates in the transparent mode when LEAB is HIGH. When LEAB is LOW, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is LOW, the A bus data is stored in the latch/flip-flop on the LOW-to-HIGH transition of CLKAB. When

OEAB is HIGH, the outputs are active. When OEAB is LOW, the outputs are in the high impedance state.

 $\overline{\text{Data}}$  flow for B to A is similar to that of A to B but uses  $\overline{\text{OEBA}}$ , LEBA, and CLKBA. The output enables are complementary (OEAB is active HIGH and  $\overline{\text{OEBA}}$  is active LOW).

### **Logic Diagram**



#### **Absolute Maximum Ratings**(Note 5) Units Symbol Parameter Value Conditions -0.5 to +7.0 ٧ Supply Voltage $V_{CC}$ ٧ DC Input Voltage -0.5 to +7.0 $V_{I}$ DC Output Voltage -0.5 to +7.0 Output in 3-STATE ٧o Output in HIGH or LOW State (Note 6) -0.5 to $V_{\rm CC} + 0.5$ DC Input Diode Current -50 V<sub>I</sub> < GND mΑ $I_{IK}$ $I_{OK}$ DC Output Diode Current -50 V<sub>O</sub> < GND mΑ +50 $V_O > V_{CC}$ DC Output Source/Sink Current ±50 mΑ Ю $I_{CC}$ DC Supply Current per Supply Pin ±100 mΑ DC Ground Current per Ground Pin ±100 mΑ $I_{GND}$ Storage Temperature -65 to +150 $T_{STG}$

### **Recommended Operating Conditions** (Note 7)

Symbol	Parameter	Min	Max	Units	
V <sub>CC</sub>	Supply Voltage	Operating	2.0	3.6	V
		Data Retention	1.5	3.6	V
V <sub>I</sub>	Input Voltage		0	5.5	V
V <sub>O</sub>	Output Voltage	HIGH or LOW State	0	V <sub>CC</sub>	V
		3-STATE	0	5.5	V
I <sub>OH</sub> /I <sub>OL</sub>	Output Current	$V_{CC} = 3.0V - 3.6V$		±24	
		$V_{CC} = 2.7V - 3.0V$ $V_{CC} = 2.3V - 2.7V$		±12	mA
		$V_{CC} = 2.3V - 2.7V$		±8	
T <sub>A</sub>	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, V <sub>IN</sub> = 0.8V–2.0V, V <sub>CC</sub> = 3.0V		0	10	ns/V

Note 5: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 6: I<sub>O</sub> Absolute Maximum Rating must be observed.

Note 7: Unused (inputs or I/Os) must be held HIGH or LOW. They may not float.

### **DC Electrical Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub>	$T_A = -40^{\circ}C$ to $+85^{\circ}C$		Units
Syllibol		Conditions	(V)	Min	Max	Office
V <sub>IH</sub>	HIGH Level Input Voltage		2.3 – 2.7	1.7		V
			2.7 – 3.6	2.0		· •
/ <sub>IL</sub>	LOW Level Input Voltage		2.3 – 2.7		0.7	V
			2.7 – 3.6		8.0	v
/он	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	2.3 – 3.6	V <sub>CC</sub> - 0.2		
		$I_{OH} = -8 \text{ mA}$	2.3	1.8		
		$I_{OH} = -12 \text{ mA}$	2.7	2.2		٧
		$I_{OH} = -18 \text{ mA}$	3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2.2		
V <sub>OL</sub>	LOW Level Output Voltage	$I_{OL} = 100 \mu A$	2.3 – 3.6		0.2	
		$I_{OL} = 8 \text{ mA}$	2.3		0.6	
		$I_{OL} = 12 \text{ mA}$	2.7		0.4	٧
		$I_{OL} = 16 \text{ mA}$	3.0		0.4	
		$I_{OL} = 24 \text{ mA}$	3.0		0.55	
I	Input Leakage Current	$0 \le V_1 \le 5.5V$	2.3 – 3.6		±5.0	μΑ
OZ	3-STATE I/O Leakage	$0 \le V_O \le 5.5V$	2.3 – 3.6		±5.0	μА
		$V_I = V_{IH}$ or $V_{IL}$				μА
OFF	Power-Off Leakage Current	$V_{1} \text{ or } V_{O} = 5.5 V$	0		10	μΑ

## DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	v <sub>cc</sub>	$T_A = -40^{\circ}$	C to +85°C	Units
C,	T diamoto.	00.12.110.110	(V)	Min	Max	•
Icc	Quiescent Supply Current	$V_I = V_{CC}$ or GND	2.3 – 3.6		20	μА
		$3.6V \le V_I, V_O \le 5.5V \text{ (Note 8)}$	2.3 – 3.6		±20	μΛ
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	$V_{IH} = V_{CC} - 0.6V$	2.3-3.6		500	μΑ

Note 8: Outputs disabled or 3-STATE only.

### **AC Electrical Characteristics**

	Parameter		T <sub>A</sub> =	–40°C to +	85°C, R <sub>L</sub> =	500Ω			
Symbol		V <sub>CC</sub> = 3.5	3V ± 0.3V	V <sub>CC</sub>	= 2.7V	V <sub>CC</sub> = 2.	5V ± 0.2V	Units	
Syllibol		C <sub>L</sub> =	C <sub>L</sub> = 50 pF		C <sub>L</sub> = 50 pF		C <sub>L</sub> = 30 pF		
		Min	Max	Min	Max	Min	Max		
f <sub>MAX</sub>	Maximum Clock Frequency	170						MHz	
t <sub>PHL</sub>	Propagation Delay	1.5	6.0	1.5	7.0	1.5	7.2	ns	
t <sub>PLH</sub>	Bus to Bus	1.5	6.0	1.5	7.0	1.5	7.2	115	
t <sub>PHL</sub>	Propagation Delay	1.5	6.7	1.5	8.0	1.5	8.4		
t <sub>PLH</sub>	Clock to Bus	1.5	6.7	1.5	8.0	1.5	8.4	ns	
t <sub>PHL</sub>	Propagation Delay	1.5	7.0	1.5	8.0	1.5	8.4		
t <sub>PLH</sub>	LE to Bus	1.5	7.0	1.5	8.0	1.5	8.4	ns	
t <sub>PZL</sub>	Output Enable Time	1.5	7.2	1.5	8.2	1.5	9.4	ns	
$t_{PZH}$		1.5	7.2	1.5	8.2	1.5	9.4	115	
t <sub>PLZ</sub>	Output Disable Time	1.5	7.0	1.5	8.0	1.5	8.4		
$t_{PHZ}$		1.5	7.0	1.5	8.0	1.5	8.4	ns	
ts	Setup Time	2.5		2.5		3.0		ns	
t <sub>H</sub>	Hold Time	1.5		1.5		2.0		ns	
t <sub>W</sub>	Pulse Width	3.0		3.0		3.5		ns	
toshl	Output to Output Skew		1.0						
toslh	(Note 9)		1.0					ns	

Note 9: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (toSHL), or LOW-to-HIGH (toSLH).

### **Dynamic Switching Characteristics**

Symbol	Parameter Conditions		V <sub>cc</sub>	$T_A = 25^{\circ}C$	Units
Symbol			(V)	Typical	Oille
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	0.8	V
		$C_L = 30 \text{ pF}, V_{IH} = 2.5V, V_{IL} = 0V$	2.5	0.6	V
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	-0.8	V
		$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	2.5	-0.6	V

### Capacitance

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	7	pF
C <sub>I/O</sub>	Input/Output Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC} = 3.3V$ , $V_{I} = 0V$ or $V_{CC}$ , $f = 10$ MHz	20	pF

### AC LOADING and WAVEFORMS Generic for LCX Family

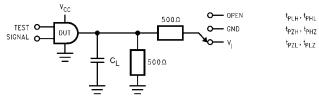
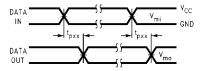
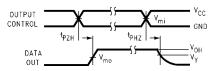


FIGURE 1. AC Test Circuit ( $C_L$  includes probe and jig capacitance)

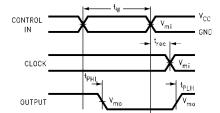
Test	Switch
t <sub>PLH</sub> , t <sub>PHL</sub>	Open
t <sub>PZL</sub> , t <sub>PLZ</sub>	6V at $V_{CC}$ = 3.3 $\pm$ 0.3V $V_{CC}$ x 2 at $V_{CC}$ = 2.5 $\pm$ 0.2V
$t_{PZH},t_{PHZ}$	GND



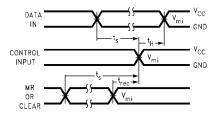
Waveform for Inverting and Non-Inverting Functions



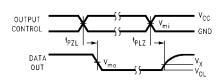
3-STATE Output High Enable and Disable Times for Logic



Propagation Delay. Pulse Width and t<sub>rec</sub> Waveforms



Setup Time, Hold Time and Recovery Time for Logic



3-STATE Output Low Enable and Disable Times for Logic

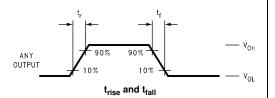
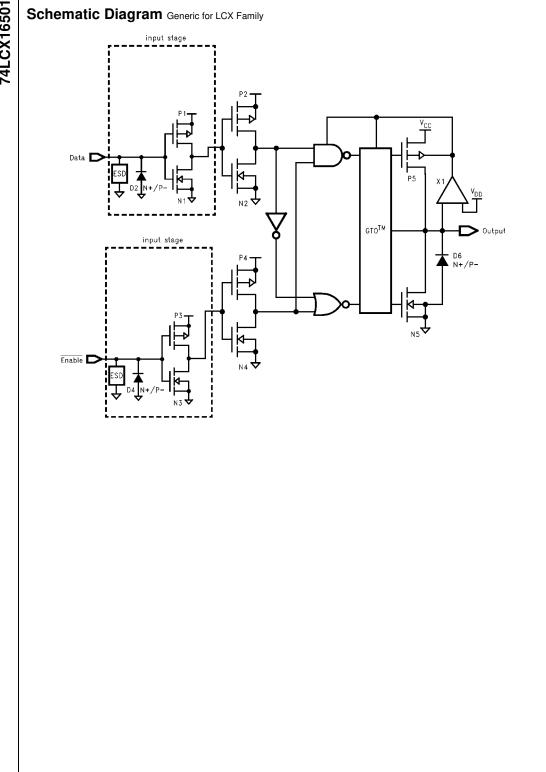
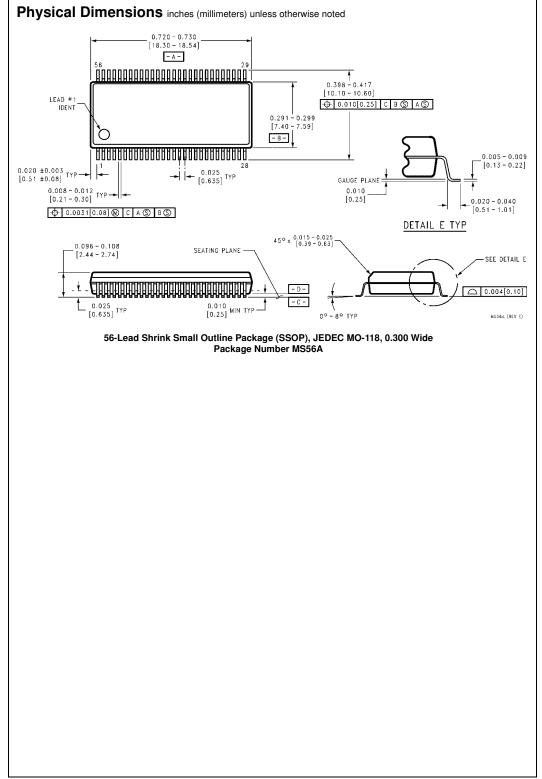
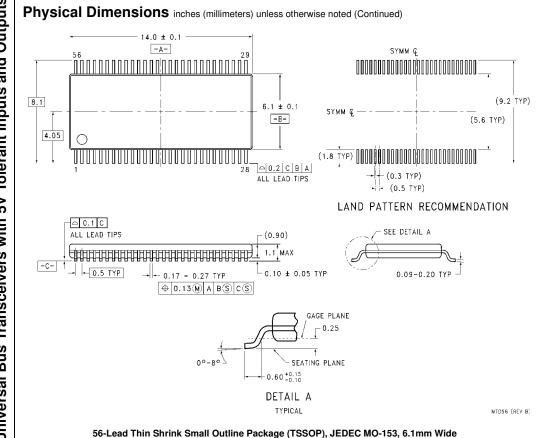


FIGURE 2. Waveforms (Input Characteristics; f =1MHz,  $t_r = t_f = 3ns$ )

Symbol		V <sub>cc</sub>	
Cymbol	$3.3V \pm 0.3V$	2.7V	$\textbf{2.5V} \pm \textbf{0.2V}$
$V_{mi}$	1.5V	1.5V	V <sub>CC</sub> /2
V <sub>mo</sub>	1.5V	1.5V	V <sub>CC</sub> /2
V <sub>x</sub>	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.3V	V <sub>OL</sub> + 0.15V
V <sub>v</sub>	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.3V	V <sub>OH</sub> – 0.15V







56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD56

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